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### **RF3854** LOW NOISE, MULTI-MODE, QUAD-BAND, QUADRATURE MODULATOR AND PA DRIVER

#### RoHS Compliant & Pb-Free Product Package Style: QFN, 24-Pin, 4x4

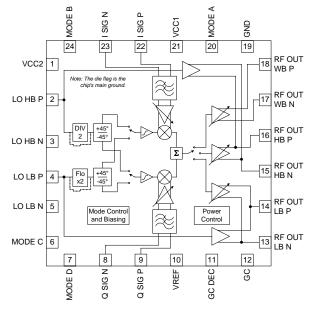


#### **Features**

- W-CDMA High/Mid/Low Power Modes
- Quad-Band Direct Quadrature Modulator
- Variable Gain PA Drivers
- GMSK Bypass Amplifiers
- LO Frequency Doubler and Divider
- Baseband Filtering
- Qualified to Infrastructure Standards

### **Applications**

- CDMA, GSM, and UMTS Basestation Architecture
- ISM Transceivers
- Broadband Fixed Wireless Access and Wireless Local Loop
- GMSK, QPSK, DQPSK, QAM Modulation



Functional Block Diagram

### **Product Description**

The RF3854 is a low noise, multi-mode, quad-band direct I/Q to RF modulator and PA driver solution designed for digital modulation applications ranging from 800MHz to 2000MHz. Frequency doublers, dividers and LO buffers are included to support a variety of LO generation options. Dynamic power control is supported through a single analog input giving 90dB of power control range for the W-CDMA mode and 40dB of power control in the other two modes. Three sets of RF outputs are provided: high band and low band low noise EDGE/GMSK outputs, as well as one wideband W-CDMA output. The device is designed for 2.7V to 3.3V operation, and is assembled in a plastic, 24-pin, 4mmx4mm QFN.

#### **Ordering Information**

RF3854Low Noise, Multi-Mode, Quad-Band, Quadrature Modulator<br/>and PA DriverRF3854PCBA-41XFully Assembled Evaluation Board

#### **Optimum Technology Matching® Applied**

| 🗌 GaAs HBT  | SiGe BiCMOS | GaAs pHEMT | 🗌 GaN HEMT |
|-------------|-------------|------------|------------|
| GaAs MESFET | 🗌 Si BiCMOS | Si CMOS    |            |
| InGaP HBT   | SiGe HBT    | 🗌 Si BJT   |            |

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#### **Absolute Maximum Ratings**

| Parameter                     | Rating       | Unit |
|-------------------------------|--------------|------|
| Supply Voltage                | -0.5 to 3.6  | V    |
| Storage Temperature           | -40 to +150  | °C   |
| Operating Ambient Temperature | -40 to +85   | °C   |
| Input Voltage, any pin        | -0.5 to +3.6 | V    |
| Input Power, any pin          | +5           | dBm  |

Caution! ESD sensitive device.

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RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

| Devenator   |           | Specification |            | 11         | Condition   |
|---|-----------|---------------|------------|------------|---|
| Parameter   | Min.      | Тур.          | Max.       | Unit       | Condition   |
| Output Performance with                             | Modula    | ted Basebar   | d Inputs   |            |   |
| Low Band EDGE 8PSK Mode                             | e (GSM85  | 0/GSM900)     |            |            |   |
| Mode=Low Band FLOx1 (see                            | Control L | ogic Truth Ta | ble for Mo | de Control |   |
| Settings)   |           | -             |            |            |   |
| Output Power  |           |               |            |            | V <sub>CC</sub> =2.7V, T=+25°C                          |
| Maximum Output Power with 8PSK<br>Modulated Signal* |           |               |            |            |   |
| Maximum VGC   | 0         | +2.5          |            | dBm        | While meeting spectral mask                             |
| Minimum VGC   |           | -39           | -37        | dBm        | While meeting spectral mask                             |
| Gain Range  |           | 42            |            | dB         | Difference between output power at GC=2.0V and GC=0.2V. |
| Out-of-Band Emission                                |           |               |            |            |   |
| Spectrum Emission Mask*                             |           |               |            |            |   |
| Frequency Spacing                                   |           |               |            |            |   |
| 200kHz  |           | -36           | TBD        | dBc        | 30 kHz BW   |
| 250kHz  |           | -43           | TBD        | dBc        | 30 kHz BW   |
| 400kHz  |           | -67           | TBD        | dBc        | 30 kHz BW   |
| 600kHz to 1800kHz                                   |           | -73           |            | dBc        | 30kHz BW  |
| 1800kHz to 3000kHz                                  |           | -73           |            | dBc        | 100kHz BW   |
| 3000kHz to 6000kHz                                  |           | -73           |            | dBc        | 100kHz BW   |
| <u>≥</u> 6000kHz                                    |           | -75           |            | dBc        | 100kHz BW   |
| Error Vector Magnitude                              |           |               |            |            | 8PSK Modulation   |
| RMS*  |           | 2             | 3          | %          |   |
| Origin Offset*                                      |           | -40           | -34        | dB         |   |
| Peak*   |           | 4             | 9          | %          |   |
| Output Noise  |           |               |            |            |   |
| At F <sub>C</sub> ±20MHz*                           |           |               |            |            |   |
| Relative Noise at:                                  |           |               |            |            |   |
| Maximum Gain  |           | -156          |            | dBc/Hz     | GC=2.0V, IQ=1.2V <sub>P-P</sub> 8PSK                    |
|   |           | -152          |            | dBc/Hz     | GC=2.0V to 1.4V   |
| Absolute Noise at:                                  |           |               |            |            |   |
| Maximum Gain  |           | -156          |            | dBm        | GC=2.0V, IQ=0V <sub>P-P</sub>                           |
| All Gain Settings                                   |           | -154          |            | dBm        | IQ=1.2V <sub>P-P</sub> 8PSK                             |

\* Not tested in Production





| Descention  |          | Specification | n         | 11               |  |
|---|----------|---------------|-----------|------------------|--|
| Parameter   | Min.     | Тур.          | Max.      | Unit             | Condition  |
| General Conditions                                  |          |               |           |                  |  |
| Local Oscillator                                    |          |               |           |                  |  |
| LO LB Input Frequency                               | 824      |               | 915       | MHz              |  |
| RF LB Output Frequency                              | 824      |               | 915       | MHz              |  |
| Input Power   | -6.0     | 0.0           | +3.0      | dBm              |  |
| IQ Baseband Inputs                                  |          |               |           |                  | 8PSK   |
| IQ Level  |          | 1.2           |           | V <sub>P-P</sub> | Input IQ signal driven differentially and in quadrature. |
| IQ Common Mode                                      |          | 1.2           |           | V                |  |
| Input Bandwidth                                     | 0.7      | 1.0           |           | MHz              |  |
| Baseband Filter Attenuation                         | 20       |               |           | dB               | At 20MHz offset  |
| Output Performance with                             | n Modula | ted Baseba    | nd Inputs |                  |  |
| High Band EDGE 8PSK Mod                             | e (DCS18 | 300/PCS190    | 0)        |                  |  |
| Mode=High Band F <sub>LO</sub> x1 (se               | •        | •             |           | de Control       |  |
| Settings)   |          |               |           |                  |  |
| Output Power  |          |               |           |                  | V <sub>CC</sub> =2.7V, T=+25°C                           |
| Maximum Output Power with 8PSK<br>Modulated Signal* |          |               |           |                  |  |
| Maximum VGC   | -1       | +1.5          |           | dBm              | While meeting spectral mask                              |
| Minimum VGC   |          | -40           | -38       | dBm              | While meeting spectral mask                              |
| Gain Range  |          | 42            |           | dB               | Difference between output power at GC=2.0V and GC=0.2V.  |
| Out-of-Band Emission                                |          |               |           |                  |  |
| Spectrum Emission Mask*                             |          |               |           |                  |  |
| Frequency Spacing                                   |          |               |           |                  |  |
| 200kHz  |          | -36           | TBD       | dBc              | 30 kHz BW  |
| 250kHz  |          | -43           | TBD       | dBc              | 30 kHz BW  |
| 400kHz  |          | -67           | TBD       | dBc              | 30 kHz BW  |
| 600kHz to 1800kHz                                   |          | -73           |           | dBc              | 30kHz BW   |
| 1800kHz to 3000kHz                                  |          | -73           |           | dBc              | 100kHz BW  |
| 3000kHz to 6000kHz                                  |          | -73           |           | dBc              | 100kHz BW  |
| <u>&gt;</u> 6000kHz                                 |          | -75           |           | dBc              | 100kHz BW  |
| Error Vector Magnitude                              |          |               |           |                  | 8PSK Modulation  |
| RMS*  |          | 1.3           | 3         | %                |  |
| Origin Offset*                                      |          | -37           | -30       | dB               |  |
| Peak*   |          | 3             | 11        | %                |  |
| Output Noise  |          |               |           |                  |  |
| At F <sub>C</sub> ±20MHz*                           |          |               |           |                  |  |
| Relative Noise at:                                  |          |               |           |                  |  |
| Maximum Gain  |          | -154          |           | dBc/Hz           | GC=2.0V, IQ=1.2V <sub>P-P</sub> 8PSK                     |
|   |          | -150          |           | dBc/Hz           | GC=2.0V to 1.4V  |
| Absolute Noise at:                                  |          |               |           | ,                |  |
| Maximum Gain  |          | -153          |           | dBm              | GC=2.0V, IQ=0V <sub>P-P</sub>                            |
| All Gain Settings                                   |          | -151          |           | dBm              | IQ=1.2V <sub>P-P</sub> 8PSK                              |
| * Not tostod in Production                          |          |               |           |                  | · - · P-P - · - · ·                                      |

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| <b>_</b>  |           | Specification  |            |                  |   |
|---|-----------|----------------|------------|------------------|---|
| Parameter   | Min.      | Тур.           | Max.       | Unit             | Condition   |
| General Conditions                                    |           |                |            |                  |   |
| Local Oscillator                                      |           |                |            |                  |   |
| LO HB Input Frequency                                 | 1710      |                | 1910       | MHz              |   |
| RF HB Output Frequency                                | 1710      |                | 1910       | MHz              |   |
| Input Power   | -6.0      | 0.0            | +3.0       | dBm              |   |
| IQ Baseband Inputs                                    |           |                |            |                  | 8PSK  |
| IQ Level  |           | 1.2            |            | V <sub>P-P</sub> | Input IQ signal driven differentially and in quadrature.          |
| IQ Common Mode  |           | 1.2            |            | V                |   |
| Input Bandwidth                                       | 0.7       | 1.0            |            | MHz              |   |
| Baseband Filter Attenuation                           | 20        |                |            | dB               | At 20 MHz offset  |
| Output Performance with                               | n Modula  | ted Baseban    | d Inputs   |                  |   |
| W-CDMA Mode   |           |                |            |                  |   |
| Mode=Wideband F <sub>LO</sub> x2 (se                  | e Control | Logic Truth Ta | ble for Mo | de Control       |   |
| Settings)   | o oontioi |                |            |                  |   |
| Output Power  |           |                |            |                  | $V_{CC}$ =2.7V, T=+25°C, while meeting 48dBc<br>ALCR              |
| Maximum Output Power with<br>W-CDMA Modulated Signal* |           |                |            |                  |   |
| High Power Mode                                       | 3         | 6              |            | dBm              | GC=2.0V   |
| Medium Power Mode                                     | -4        | -1             |            | dBm              | GC=1.5V   |
| Gain Range  |           |                |            |                  | Difference between output power at GC=2.0V and GC=0.2V.           |
| High Power Mode                                       |           | 90             |            | dB               |   |
| Gain Step   |           |                |            |                  | Gain step when switching between power modes in either direction. |
| High Power to Medium Power                            |           | ±0.5           |            | dB               | GC=1.4V   |
| Medium Power to Low Power                             |           | TBD            |            | dB               | GC=TBD  |
| Out-of-Band Emission                                  |           |                |            |                  |   |
| Adjacent Channel Leakage Power<br>Ratio (ALCR)*       |           |                |            |                  |   |
| Channel Spacing                                       |           |                |            |                  |   |
| ±5MHz   |           | 50             |            | dBc              | 3.84MHz relative to channel power                                 |
| ±10MHz  |           | 65             |            | dBc              | 3.84MHz relative to channel power                                 |
| Error Vector Magnitude                                |           |                |            |                  |   |
| RMS*  |           | 1.4            |            | %rms             | 3GPP W-CDMA   |
| Output Noise  |           |                |            |                  |   |
| At F <sub>C</sub> ±40MHz*                             |           | -152           | -146       | dBc/Hz           | GC=2.0V   |
|   |           |                | -146       | dBc/Hz           | GC=2.0V to 1.5V   |

\* Not tested in Production



| Deveneetev  | Parameter Specification Unit |                | 11         | Condition        |  |
|---|------------------------------|----------------|------------|------------------|--|
| Parameter   | Min.                         | Тур.           | Max.       | Unit             | Condition  |
| General Conditions  |                              |                |            |                  |  |
| Local Oscillator  |                              |                |            |                  |  |
| LO LB Input Frequency   | 960                          |                | 990        | MHz              |  |
| RF WB Output Frequency  | 1920                         |                | 1980       | MHz              |  |
| Input Power   | -10.0                        | 0.0            | +3.0       | dBm              |  |
| IQ Baseband Inputs  |                              |                |            |                  | 3GPP W-CDMA<br>HQPSK, 1DPCCH+1DPDCH  |
| IQ Level  |                              | 0.8            |            | V <sub>P-P</sub> | Input IQ signal driven differentially and in quadrature.   |
| IQ Common Mode  |                              | 1.2            |            | V                |  |
| Input Bandwidth   | 8                            | 11             |            | MHz              |  |
| Baseband Filter Attenuation   | 10                           |                |            | dB               | At 40MHz offset  |
| Output Performance with   | CW Ba                        | seband Inpu    | ts         |                  |  |
| Wideband Mode   |                              |                |            |                  |  |
| Mode=Wideband F <sub>LO</sub> x2 (see                                 | o Control                    | Logic Truth To | blo for Mo | do Control       |  |
| Settings)   | e controi                    | Logic mutilita |            | de control       |  |
| VGA and PA Driver   |                              |                |            |                  | $V_{CC}$ =2.7V, T=+25°C, L0=975MHz to<br>990MHz at -10dBm, IQ=540mV <sub>P-P</sub> ** at<br>100kHz, unless otherwise noted |
| Output Power W-CDMA Modu-<br>lated*                                   |                              | 5              |            | dBm              | GC=2.0V, IQ=0.8V <sub>P-P</sub> at HQPSK   |
| Output Power CW   | 2                            | 5              | 8          | dBm              | GC=2.0V  |
| Gain Control Voltage Range  | 0.2                          |                | 2.0        | V                |  |
| Gain Control Range  |                              | 92             |            | dB               | Difference between output power at GC=2.0V and GC=0.2V   |
| Gain Control Slope  |                              | 73             |            | dB/V             | Calculated between GC=1.0V and 0.5V  |
| Modulator   |                              |                |            |                  |  |
| Sideband Suppression  |                              | -48            | -30        | dBc              | GC=2.0V, No I/Q adjustment   |
| *   |                              | -50            | -30        | dBc              | GC=1.5V, No I/Q adjustment   |
| *   |                              | -50            | -30        | dBc              | GC=1.0V, No I/Q adjustment   |
| *   |                              | -50            | -30        | dBc              | GC=0.5V. No I/Q adjustment   |
| Carrier Suppression   |                              | -42            | -30        | dBc              | GC=2.0V, No I/Q adjustment   |
|   |                              | -41            | -30        | dBc              | GC=1.5V, No I/Q adjustment   |
|   |                              | -38            | -30        | dBc              | GC=1.0V, No I/Q adjustment   |
|   |                              | -23            | -10        | dBc              | GC=0.5V. No I/Q adjustment   |
| 3rd Harmonic of Modulation<br>Suppression at F <sub>C</sub> -3x300kHz |                              | -55            | -50        | dBc              | GC=2.0V  |
| Spurious Outputs  |                              |                |            |                  |  |
| Spurious Output at Integer Multi-<br>ples of FLO LB*                  |                              |                |            |                  | GC=2.0V, I/Q=540mV <sub>P-P</sub> at 100kHz  |
| FLO LB  |                              | -60.0          |            | dBm              | FLO LB leakage   |
| 4xFLO LB  |                              | -14.0          | 0          | dBm              | Second harmonic of carrier   |
| 6xFLO LB  |                              | -47.0          | 0          | dBm              | Third harmonic of carrier  |
| Output Compression  |                              | -              | -          |                  |  |
| Output P1dB*  |                              | +11.5          |            | dBm              | I/Q=100kHz   |
| * Not tested in Production  |                              |                | -          | 0.011            | 7 2 2001112  |

\* Not tested in Production

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| Doromotor  | Parameter Specification Unit |                 | llait      | Condition  |  |
|--|------------------------------|-----------------|------------|------------|--|
| Parameter  | Min.                         | Тур.            | Max.       | Onit       |  |
| Intermodulation  |                              |                 |            |            |  |
| Output IP3*  |                              | +20             |            | dBm        | GC=2.0V. Extrapolated from IM3 with two baseband tones at 90 kHz and 110 kHz applied differentially, in quadrature, at both I and Q inputs, each tone $400 \text{ mV}_{P-P}$ |
| Intermodulation IM3 tone at $F_C$ +70kHz and $F_C$ +130kHz relative to tones at $F_C$ +90kHz and $F_C$ +110kHz |                              | -37             |            | dBc        | GC=2.0V  |
|  |                              | -40             |            | dBc        | GC=1.5V  |
| Output Performance with  | CW Ba                        | seband Input    | s          | 1          |  |
| Low Band Mode (GSM850/   | GSM900                       | )               |            |            |  |
| Mode=Low Band F <sub>LO</sub> x1 (see  | e Control                    | Logic Truth Tal | ble for Mo | de Control |  |
| Settings)  |                              |                 |            |            |  |
| VGA and PA Driver  |                              |                 |            |            | $V_{CC}$ =2.7V, T=+25°C,<br>LO=824MHz to 915MHz at OdBm,<br>IQ=800mV <sub>P.P</sub> ** at 100kHz,<br>unless otherwise noted  |
| Output Power 8PSK Modulated*   |                              | +2.5            |            | dBm        | GC=2.0V, IQ=1.2V <sub>P-P</sub> 8PSK   |
| Output Power CW  | 0                            | 2.2             | +5         | dBm        | GC=2.0V, IQ=800mV <sub>P-P</sub> at 100kHz   |
|  |                              | -1.2            |            | dBm        | GC=1.5V, IQ=800mV <sub>P-P</sub> at 100kHz   |
| *  |                              | -13.5           |            | dBm        | GC=1.0V, IQ=800mV <sub>P-P</sub> at 100kHz   |
|  |                              | -30             |            | dBm        | GC=0.5V, IQ=800mV <sub>P-P</sub> at 100kHz   |
|  | -44                          | -40             | -37        | dBm        | GC=0.2V, IQ=800mV <sub>P-P</sub> at 100kHz   |
| Gain Control Voltage Range   | 0.2                          |                 | 2.0        | V          |  |
| Gain Control Range   |                              | 42              |            | dB         | Difference between output power at GC=2.0V and GC=0.2V   |
| Gain Control Slope   |                              | 28              |            | dB/V       | Calculated between GC=0.5V and 1.5V  |
| Modulator  |                              |                 |            |            |  |
| Sideband Suppression   |                              | -36             | -30        | dBc        | GC=2.0V, No I/Q adjustment   |
| *  |                              | -36             | -30        | dBc        | GC=1.5V, No I/Q adjustment   |
| *  |                              | -36             | -30        | dBc        | GC=1.0V, No I/Q adjustment   |
| *  |                              | -36             | -30        | dBc        | GC=0.5V, No I/Q adjustment   |
| *  |                              | -36             | -30        | dBc        | GC=0.2V, No I/Q adjustment   |
| Carrier Suppression  |                              | -44             | -34        | dBc        | GC=2.0V, No I/Q adjustment   |
|  |                              | -44             | -34        | dBc        | GC=1.5V, No I/Q adjustment   |
| *  |                              | -44             | -34        | dBc        | GC=1.0V, No I/Q adjustment   |
|  |                              | -44             | -34        | dBc        | GC=0.5V, No I/Q adjustment   |
|  |                              | -40             | -34        | dBc        | GC=0.2V, No I/Q adjustment   |
| 3rd Harmonic of Modulation<br>Suppression at F <sub>C</sub> -3x300kHz  |                              | -49             | -40        | dBc        | GC=2.0V  |

\* Not tested in Production





| Parameter  | Specification |                 |             | 11         |  |
|--|---------------|-----------------|-------------|------------|--|
| Parameter  | Min.          | Тур.            | Max.        | Unit       | Condition  |
| Spurious Outputs   |               |                 |             |            | F <sub>LO</sub> /2 Mode  |
| Spurious Outputs at Integer<br>Harmonics of 1/2xFLOHB*   |               |                 |             |            | GC=2.0V, I/Q=800mV <sub>P.P</sub> at 100kHz  |
| FLO HB   |               | -62.0           |             | dBm        | Second harmonic of carrier and LO leakage  |
| (3/2)×FLO LB   |               | -19.0           |             | dBm        | Third harmonic of carrier  |
| Output Compression   |               |                 |             |            |  |
| Output P1dB*   |               | +7.0            |             | dBm        | I/Q=100kHz   |
| Output Performance with  | CW Bas        | seband Input    | ts          |            |  |
| Low Band Mode (GSM850/   | GSM900        | ), cont'd       |             |            |  |
| Mode=Low Band F <sub>LO</sub> x1 (see  | e Control     | Logic Truth Ta  | ble for Mo  | de Control |  |
| Settings)  |               | U               |             |            |  |
| Intermodulation  |               |                 |             |            |  |
| Output IP3*  |               | +20.0           |             | dBm        | GC=2.0V. Extrapolated from IM3 with two baseband tones at 90 kHz and 110 kHz applied differentially, in quadrature, at both I and Q inputs, each tone $400 \text{ mV}_{P-P}$ |
| Intermodulation IM3 tone at $F_{C}$ +70kHz and $F_{C}$ +130kHz relative to tones at $F_{C}$ +90kHz and $F_{C}$ +110kHz |               | -48             |             | dBc        | GC=2.0V  |
| Low Band Bypass Mode (GS   | M850/G        | SM900)          |             | •          |  |
| Mode=Low Band Bypass (se   | ee Contro     | I Logic Truth 1 | Table for N | lode       |  |
| Control Settings)  |               |                 |             |            |  |
| PA Driver  |               |                 |             |            | V <sub>CC</sub> =2.7V  |
| GMSK Input Power*  | -3            | 0               | +3          | dBm        | At LO LB input from a 50 $\Omega$ source.  |
| GMSK Output Power  | 5.0           | 7.5             | 10.0        | dBm        | At RF LB output  |
| Output Impedance*  |               | 50              |             | Ω          |  |
| Output Noise   |               |                 |             |            |  |
| At F <sub>C</sub> ±20MHz*  |               | -161            | -159        | dBc/Hz     | AM+PM noise, LO=0dBm   |



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| Paramotor   |          | Specification | n           | Unit       | Condition  |
|---|----------|---------------|-------------|------------|--|
| Parameter   | Min.     | Тур.          | Max.        | Unit       | Condition  |
| Output Performance with   | CW Ba    | seband Inpu   | ıts         |            |  |
| High Band Mode (DCS1800   | / PCS190 |               |             |            |  |
| Mode=High Band $F_{IO}$ x1 (see                                       | <b>,</b> | ,             | able for Mo | de Control |  |
| Settings)   |          |               |             |            |  |
|   |          |               |             |            | V <sub>CC</sub> =2.7V, T=+25°C,                        |
| VGA and PA Driver   |          |               |             |            | LO = 1710  MHz to  1910  MHz at  0  dBm,               |
| VGA and PA Driver   |          |               |             |            | IQ=800mV <sub>P-P</sub> ** at 100kHz,                  |
|   |          |               |             |            | unless otherwise noted                                 |
| Output Power 8PSK Modulated*  | 0        | 2.2           |             | dBm        | GC=2.0V, IQ=1.2V <sub>P-P</sub> 8PSK                   |
| Output Power CW   | 0        | 2             | +6.0        | dBm        | GC=2.0V, IQ=800mV <sub>P-P</sub> at 100kHz             |
|   |          | -1.6          |             | dBm        | GC=1.5V, IQ=800mV <sub>P-P</sub> at 100kHz             |
| *   |          | -17.6         |             | dBm        | GC=1.0V, IQ=800mV <sub>P-P</sub> at 100kHz             |
|   |          | -30           |             | dBm        | GC=0.5V, IQ=800mV <sub>P-P</sub> at 100kHz             |
|   | -44      | -40           | -37         | dBm        | GC=0.2V, IQ=800mV <sub>P-P</sub> at 100kHz             |
| Gain Control Voltage Range  | 0.2      |               | 2.0         | V          |  |
| Gain Control Range  |          | 42            |             | dB         | Difference between output power at GC=2.0V and GC=0.2V |
| Gain Control Slope  |          | 28            |             | dB/V       | Calculated between GC=0.5V and 1.5V                    |
| Modulator   |          |               |             |            |  |
| Sideband Suppression  |          | -45           | -30         | dBc        | GC=2.0V, No I/Q adjustment                             |
| *   |          | -45           | -30         | dBc        | GC=1.5V, No I/Q adjustment                             |
| *   |          | -45           | -30         | dBc        | GC=1.0V, No I/Q adjustment                             |
| *   |          | -45           | -30         | dBc        | GC=0.5V, No I/Q adjustment                             |
| *   |          | -45           | -30         | dBc        | GC=0.2V, No I/Q adjustment                             |
| Carrier Suppression   |          | -40           | -34         | dBc        | GC=2.0V, No I/Q adjustment                             |
|   |          | -40           | -34         | dBc        | GC=1.5V, No I/Q adjustment                             |
| *   |          | -40           | -33         | dBc        | GC=1.0V, No I/Q adjustment                             |
|   |          | -39           | -30         | dBc        | GC=0.5V, No I/Q adjustment                             |
|   |          | -37           | -30         | dBc        | GC=0.2V, No I/Q adjustment                             |
| 3rd Harmonic of Modulation<br>Suppression at F <sub>C</sub> -3x300kHz |          | -50           | -40         | dBc        | GC=2.0V  |
| Spurious Outputs  |          |               |             |            | F <sub>LO</sub> x2 Mode                                |
| Spurious Outputs at Integer<br>Harmonics of 1/2xFLOHB                 |          |               |             |            | GC=2.0V, I/Q=800mV <sub>P-P</sub> at 100 kHz           |
| FLO LB  |          | -70.0         |             | dBm        | FLO LB leakage   |
| 4xFLO LB  |          | -25.0         |             | dBm        | Second harmonic of carrier                             |
| 6xFLO LB  |          | -40.0         |             | dBm        | Third harmonic of carrier                              |
| Output Compression  |          |               |             |            |  |
| Output P1dB*  |          | +8.0          |             | dBm        | I/Q=100kHz   |





| Specification  |           |                |            |            |  |  |
|--|-----------|----------------|------------|------------|--|--|
| Parameter  | Min.      | -              | Max.       | Unit       | Condition  |  |
| Output Parformanaa with  |           | Typ.           |            |            |  |  |
| Output Performance with  |           | -              | 5          |            |  |  |
| High Band Mode (DCS1800  | ,         | <i>,</i> ,     |            |            |  |  |
| Mode=High Band F <sub>LO</sub> x1 (se  | e Control | Logic Truth Ta | ble for Mo | de Control |  |  |
| Settings)  |           |                |            |            |  |  |
| Intermodulation  |           |                |            |            |  |  |
| Output IP3*  |           | +20            |            | dBm        | GC=2.0V. Extrapolated from IM3 with two baseband tones at 90kHz and 110kHz applied differentially, in quadrature, at both I and Q inputs, each tone $400 \text{mV}_{\text{P-P}}$ |  |
| Intermodulation IM3 tone at $F_C$ +70kHz and $F_C$ +130kHz relative to tones at $F_C$ +90kHz and $F_C$ +110kHz |           | -53            | -42        | dBc        | GC=2.0V  |  |
| Output Performance with  | CW Bas    | seband Input   | S          |            |  |  |
| Wideband Mode  |           |                |            |            |  |  |
| Mode=Wideband F <sub>LO</sub> x2 (se<br>Settings)  | e Control | Logic Truth Ta | ble for Mo | de Control |  |  |
| VGA and PA Driver  |           |                |            |            | $V_{CC}$ =2.7V, T=+25°C, L0=975MHz to<br>990MHz at -10dBm, IQ=540mV <sub>P-P</sub> ** at<br>100kHz, unless otherwise noted   |  |
| Output Power W-CDMA Modu-<br>lated*  |           | 5              |            | dBm        | GC=2.0V, IQ=0.8V <sub>P-P</sub> at HQPSK   |  |
| Output Power CW  | 2         | 5              | 8          | dBm        | GC=2.0V  |  |
| Gain Control Voltage Range   | 0.2       |                | 2.0        | V          |  |  |
| Gain Control Range   |           | 92             |            | dB         | Difference between output power at GC=2.0V and GC=0.2V   |  |
| Gain Control Slope   |           | 73             |            | dB/V       | Calculated between GC=1.0V and 0.5V  |  |
| Modulator  |           |                |            |            |  |  |
| Sideband Suppression   |           | -48            | -30        | dBc        | GC=2.0V, No I/Q adjustment   |  |
| *  |           | -50            | -30        | dBc        | GC=1.5V, No I/Q adjustment   |  |
| *  |           | -50            | -30        | dBc        | GC=1.0V, No I/Q adjustment   |  |
| *  |           | -50            | -30        | dBc        | GC=0.5V, No I/Q adjustment   |  |
| Carrier Suppression  |           | -42            | -30        | dBc        | GC=2.0V, No I/Q adjustment   |  |
|  |           | -41            | -30        | dBc        | GC=1.5V, No I/Q adjustment   |  |
|  |           | -38            | -30        | dBc        | GC=1.0V, No I/Q adjustment   |  |
|  |           | -23            | -10        | dBc        | GC=0.5V, No I/Q adjustment   |  |
| 3rd Harmonic of Modulation<br>Suppression at F <sub>C</sub> -3x300kHz  |           | -55            | -50        | dBc        | GC=2.0V  |  |
| Spurious Outputs   |           |                |            |            |  |  |
| Spurious Output at Integer Multi-<br>ples of FLO LB*   |           |                |            |            | GC=2.0V, I/Q=540mV <sub>P.P</sub> at 100kHz  |  |
| FLO LB   |           | -60.0          |            | dBm        | FLO LB leakage   |  |
| 4xFLO LB   |           | -14.0          | 0          | dBm        | Second harmonic of carrier   |  |
| 6xFLO LB   |           | -47.0          | 0          | dBm        | Third harmonic of carrier  |  |
| Output Compression   |           |                |            |            |  |  |
| Output P1dB*   |           | +11.5          |            | dBm        | I/Q=100 kHz  |  |

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| Parameter  |            | Specification    |             | Unit   | Condition   |  |
|--|------------|------------------|-------------|--------|---|--|
| Falameter  | Min.       | Тур.             | Max.        | Unit   | Condition   |  |
| Intermodulation  |            |                  |             |        |   |  |
| Output IP3*  |            | +20              |             | dBm    | GC=2.0V. Extrapolated from IM3 with two baseband tones at 90kHz and 110kHz applied differentially, in quadrature, at both I and Q inputs, each tone $400 \text{mV}_{P.P}$ |  |
| Intermodulation IM3 tone at $F_C$ +70kHz and $F_C$ +130kHz relative to tones at $F_C$ +90kHz and $F_C$ +110kHz |            | -37              |             | dBc    | GC=2.0V   |  |
|  |            | -40              |             | dBc    | GC=1.5V   |  |
| High Band Bypass Mode (D   | CS1800/    | PCS1900)         |             |        |   |  |
| Mode=High Band Bypass (s<br>Control Settings)  | see Contro | ol Logic Truth 1 | Table for N | Node   |   |  |
| PA Driver  |            |                  |             |        | V <sub>CC</sub> =2.7V   |  |
| GMSK Input Power*  | -3         | 0                | +3          | dBm    | At LO LB input from a $50\Omega$ source.  |  |
| GMSK Output Power  | 4.0        | 6.8              | 9.0         | dBm    | At RF LB output   |  |
| Output Impedance*  |            | 50               |             | Ω      |   |  |
| Output Noise   |            |                  |             |        |   |  |
| At F <sub>C</sub> ±20MHz*  |            | -161             | -159        | dBc/Hz | AM+PM noise, LO=0dBm  |  |

\* Not tested in Production





| Devenenter                               |      | Specificatio | n               | 11   |  |
|--|------|--------------|-----------------|------|--|
| Parameter                                | Min. | Тур.         | Max.            | Unit | Condition  |
| General Specifications                   |      |              |                 |      |  |
| Operating Range                          |      |              |                 |      |  |
| Supply Voltage                           | 2.7  |              | 3.3             | V    |  |
| Temperature                              | -40  |              | +85             | °C   |  |
| Current Consumption                      |      |              |                 |      | Refer to Logic Control Truth Table for Mode<br>Control Pin Voltages. |
| Sleep                                    |      | <1           | 10              | μΑ   |  |
| Wideband F <sub>LO</sub> x1 (high power) |      | 114          |                 | mA   | GC=2.0V  |
| *  |      | 85           |                 | mA   | GC=0.2V  |
| (medium power)                           |      | 89           |                 | mA   | GC=2.0V  |
| *  |      | 54           |                 | mA   | GC=0.2V  |
| (low power)                              |      | 63           |                 | mA   | GC=2.0V. See Note 1.   |
| *  |      | 42           |                 | mA   | GC=0.2V. See Note 1.   |
| Wideband F <sub>LO</sub> x2 (high power) |      | 110          |                 | mA   | GC=2.0V  |
|  |      | 84           |                 | mA   | GC=0.2V  |
| (medium power)                           |      | 80           |                 | mA   | GC=2.0V  |
|  |      | 53           |                 | mA   | GC=0.2V  |
| (low power)                              |      | 54           |                 | mA   | GC=2.0V. See Note 1.   |
|  |      | 41           |                 | mA   | GC=0.2V. See Note 1.   |
| High Band F <sub>LO</sub> x2             |      | 72           |                 | mA   | GC=2.0V  |
| Low Band F <sub>LO</sub> /2              |      | 82           |                 | mA   | GC=2.0V  |
| High Band Bypass                         |      | 23           |                 | mA   |  |
| Low Band Bypass                          |      | 22           |                 | mA   |  |
| High Band F <sub>LO</sub> x1             |      | 76           |                 | mA   | GC=2.0V  |
| Low Band F <sub>LO</sub> x1              |      | 74           |                 | mA   | GC=2.0V  |
| Logic Levels                             |      |              |                 |      |  |
| Input Logic O                            | 0    |              | 0.4             | V    |  |
| Input Logic 1                            | 1.4  |              | V <sub>CC</sub> | V    |  |
| Logic Pins Input Current                 |      | <1.0         |                 | μΑ   | CMOS inputs  |
| LO Input Ports                           |      |              |                 |      |  |
| LO LB Input Frequency Range              | 800  |              | 1000            | MHz  |  |
| LO HB Input Frequency Range              | 1600 |              | 2000            | MHz  |  |
| Input Impedance                          |      | 50           |                 | Ω    | Externally matched   |

Note 1: In low power mode it is recommended that the IQ level be reduced to  $0.4V_{P,P}$ . If IQ level is >0.4 $V_{P,P}$ , this mode should be used for W-CDMA TX power levels below -20dBm (measured at antenna).

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| Parameter                             |                | Specification   |            | Unit             | Condition  |
|---------------------------------------|----------------|-----------------|------------|------------------|--|
| Farameter                             | Min. Typ. Max. |                 | Unit       | Condition        |  |
| I/Q Baseband Inputs                   |                |                 |            |                  |  |
| Baseband Input Voltage                | 1.15           |                 | 1.25       | V                | Common mode voltage  |
| Baseband Input Level                  |                |                 |            |                  |  |
| EDGE                                  |                | 1.2             |            | V <sub>P-P</sub> | Differential   |
| W-CDMA                                |                | 0.8             |            | V <sub>P-P</sub> | 1DPCCH+1DPDCH. See Note 1.                                       |
| GMSK                                  |                |                 | 1.0        | V <sub>P-P</sub> | Differential   |
| Baseband Input Impedance              |                | 100k  1pF       |            | Ω                | Measured at 100kHz   |
| Input Bandwidth                       |                |                 |            |                  |  |
| EDGE                                  | 0.7            | 1.0             |            | MHz              |  |
| W-CDMA                                | 8.0            | 11.0            |            | MHz              |  |
| Baseband Filter Attenuation           |                |                 |            |                  |  |
| EDGE                                  | 20             |                 |            | dB               | At 20MHz   |
| W-CDMA                                | 10             |                 |            | dB               | At 40 MHz  |
| Baseband Input DC Current             | -10            | 0               | 10         | μΑ               |  |
| Gain Control                          |                |                 |            |                  |  |
| Gain Control Voltage                  | 0.2            |                 | 2.2        | V                |  |
| Gain Control Impedance                |                | 10              |            | kΩ               |  |
| Output Performance with               | BTS wa         | aveform: W-C    | CDMA tes   | t model I,       | 64 DPCH  |
| Wideband Mode                         |                |                 |            |                  |  |
| Mode=Wideband F <sub>LO</sub> x1 (see | e Logic Co     | ontrol Truth Ta | ble for Mo | de Control       |  |
| Settings)                             |                |                 |            |                  |  |
| Frequency                             | 2110           |                 | 2170       | MHz              | V <sub>CC</sub> =3.3V, V <sub>GC</sub> =1.6V                     |
| Output Power                          |                | -14             |            | dBm              |  |
| Adjacent Channel Power                |                | -65             |            | dBc              | ACP measured in 3.84 MHz channel, 5 MHz off-<br>set from carrier |
| Noise Floor                           |                | -150            |            | dBm/Hz           | ±40MHz offset from carrier                                       |
|                                       |                |                 |            |                  |  |

Note 1: In low power mode it is recommended that the IQ level be reduced to  $0.4V_{P,P}$ . If IQ level is >0.4 $V_{P,P}$ , this mode should be used for W-CDMA TX power levels below -20dBm (measured at antenna).



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| Pin | Function | Description   | Interface Schematic  |
|-----|----------|---|----------------------|
| 1   | VCC2     | Supply for LO buffers, frequency doubler and dividers.  | Modulator and<br>VGA |
| 2   | LO HB P  | High band local oscillator input (1800MHz).<br>In "low band $F_{LO}/2$ " modes the signal (LOHBP-LOHBN) undergoes a frequency division of 2 to provide the low band LO signal for the modulator.<br>In "high band $F_{LO}x1$ " modes the signal (LOHBP-LOHBN) is used as the high band LO signal for the modulator.<br>In "high band bypass" a modulated DCS1800/PCS1900 signal (LOHBP-LOHBN) is switched into the RF signal path. The modulator is disabled and the signal is routed to the RFOutHb outputs through a differential PA driver amplifier.<br>The LOHBP input is AC-coupled internally.<br>The noise performance, carrier suppression at low output powers and sideband suppression all vary with LO power. The optimum LO power is between -3dBm and +3dBm. The device will work with LO powers as low as -20dBm however this is at the expense of higher phase noise in the LO circuitry and poorer sideband suppression.<br>The input impedance should be externally matched to 50Ω. The port can be driven either differentially or single ended. The port impedance does not vary significantly between active and power down modes. |                      |
| 3   | LO HB N  | The complementary LO input for both LOHBP LO signals.<br>In any of the modes the LOHB input may be driven either single ended or<br>differentially. If the LO is driven single ended then the PCB board designer<br>can ground this pin.<br>It is recommended that if this pin is grounded that it is kept isolated from<br>the GND1 pin and the die flag ground. All connections to any other ground<br>should be made through a ground plane. Poor routing of this ground signal<br>can significantly degrade the LO leakage performance.   | See pin 2.           |
| 4   | LO LB P  | Low band local oscillator input (900MHz).<br>In "wideband $F_{L0}x2$ " and "high band $F_{L0}x2$ " modes the signal (LOLBP-<br>LOLBN) is doubled in frequency to provide the LO signal for the modulator.<br>In "Low band $F_{L0}x1$ " modes the signal (LOLBP-LOLBN) is used as the LO<br>signal for the modulator.<br>In "Low band Bypass" a modulated GSM900 signal (LOLBP-LOLBN) is<br>switched into the RF signal path. The modulator is disabled and the signal<br>is routed to the RFOutLb outputs through a differential PA driver amplifier.<br>This LOLBP input is AC-coupled internally.<br>The noise performance, carrier suppression at low output powers and side-<br>band suppression performance are functions of LO power. The optimum LO<br>power is between -3dBm and +3dBm. The device will work with LO powers<br>as low as -20dBm however this is at the expense of higher noise perfor-<br>mance at high output powers and poorer sideband suppression.<br>The input impedance should be externally matched to 50 $\Omega$ . The port<br>impedance does not vary significantly between active and powered modes.                 |                      |
| 5   | LO LB N  | The complementary LO input for both LOLBP LO signals.<br>In any of the modes the LOLB input may be driven either single ended or<br>differentially. If the LO is driven single ended then the PCB board designer<br>can ground this pin.<br>It is recommended that if this pin is grounded that it is kept isolated from<br>the GND1 pin and the die flag ground. All connections to any other ground<br>should be made through a ground plane. Poor routing of this GndLO signal<br>can significantly degrade the LO leakage performance.  | See pin 4.           |

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| Pin | Function | Description  | Interface Schematic |
|-----|----------|--|---------------------|
| 6   | MODE C   | Chip enable control pin. See the Logic Truth table.<br>CMOS Logic inputs: Logic 0=0V to 0.4V; Logic 1=1.4V to V <sub>CC</sub> .  |                     |
| 7   | MODE D   | Mode control pin. See the Logic Truth table. CMOS Logic inputs: Logic 0=0V to 0.4V; Logic 1=1.4V to $V_{CC}$ .   | See pin 6.          |
| 8   | Q SIG N  | Quadrature Q channel negative baseband input port.<br>Best performance is achieved when the QSIGP and QSIGN are driven dif-<br>ferentially with a 1.2V common mode DC voltage. The recommended dif-<br>ferential drive level (V <sub>QSIGP</sub> -V <sub>QSIGN</sub> ) is 1.2V <sub>P-P</sub> for EDGE, 0.8V <sub>P-P</sub> for W-<br>CDMA modulation and 1.0V <sub>P-P</sub> for GMSK modulation.<br>This input should be DC-biased at 1.2V. In sleep mode an internal FET<br>switch is opened, the input goes high impedance and the modulator is de-<br>biased.<br>Phase or amplitude errors between the QSIGP and QSIGN signals will<br>result in a common-mode signal which may result in an increase in the<br>even order distortion of the modulation in the output spectrum.<br>DC offsets between the QSIGP and QSIGN signals will result in increased<br>carrier leakage. Small DC offsets may be deliberately applied between the<br>ISIGP/ISIGN and QSIGP/QSIGN inputs to cancel out the LO leakage. The<br>optimum corrective DC offsets will change with mode, frequency and gain<br>control.<br>Common-mode noise on the QSIGP and QSIGN should be kept low as it<br>may degrade the noise performance of the modulator.<br>Phase offsets from quadrature between the I and Q baseband signals<br>results in degraded sideband suppression. |                     |
| 9   | Q SIG P  | Quadrature Q channel negative baseband input port. See pin 8.  | See pin 8.          |
| 10  | VREF     | Voltage reference decouple.<br>External 10nF decoupling capacitor to ground.<br>The voltage on this pin is typically 1.67V when the chip is enabled. The<br>voltage is 0V when the chip is powered down.<br>The purpose of this decoupling capacitor is to filter out low frequency noise<br>(20MHz) on the gain control lines.<br>Poor positioning of the VREF decoupling capacitor can cause a degrada-<br>tion in LO leakage.<br>A voltage of around 2.5V on this pin indicates that the die flag under the<br>chip is not grounded and the chip is not biased correctly.   |                     |
| 11  | GC DEC   | Gain control voltage decouple with an external 1nF decoupling capacitor to ground.<br>The voltage on this pin is a function of gain control (GC) voltage when the chip is enabled. The voltage is 0V when the chip is powered down.<br>The purpose of this decoupling capacitor is to filter out low frequency noise (20MHz) on the gain control lines. The size capacitor on the GC DEC line will effect the settling time response to a step in gain control voltage. A 1nF capacitor equates to around 200ns settling time and a 0.5nF capacitor equates to a 100ns settling time. There is a trade-off between settling time and noise contributions by the gain control circuitry as gain control is applied.<br>Poor positioning of the VREF decoupling capacitor can cause a degradation in LO leakage.   |                     |



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| Pin | Function       | Description  | Interface Schematic  |
|-----|----------------|--|--|
| 12  | GC             | Gain control voltage. Maximum output power at 2.0V. Minimum output power at 0V. When the chip is enabled the input impedance is $10k\Omega$ to $1.67V_{DC}$ . When the chip is powered down a FET switch is opened and the input goes high impedance.  | V <sub>cco</sub><br>10 kΩ<br>1.7 V   |
| 13  | RF OUT<br>LB N | Differential low band PA driver amplifier output.<br>This output is intended for low band (GSM850/900) operation and drives a<br>differential SAW.<br>A bypass mode allows the low band PA driver amplifier's input to be<br>switched between the signal from the modulator and the signal applied at<br>LOLB. This enables a GMSK-modulated signal on the LOLB input to be<br>switched into the RF signal path.<br>The output is an open collector. The outputs are matched off-chip. | V <sub>c</sub><br>V <sub>c</sub><br>V <sub>c</sub><br>V <sub>c</sub><br>ORF OUT LB P<br>ORF OUT LB N   |
| 14  | RF OUT<br>LB P | Complementary differential low band PA driver amplifier output.<br>See pin 13.   | See pin 13.  |
| 15  | RF OUT<br>HB N | Differential high band PA Driver amplifier output.<br>This output is intended for DCS1800/PCS1900 band operation.<br>A bypass mode allows the high band PA driver amplifier's input to be<br>switched between the signal from the modulator and the signal applied at<br>LOHB. This enables a GMSK-modulated DCS1800/PCS1900 signal on the<br>LOHB input to be switched into the RF signal path.<br>The output is an open collector. The outputs are matched off-chip.                 | V <sub>CC</sub> V <sub>CC</sub><br>V <sub>CC</sub><br>V <sub>CC</sub><br>V <sub>CC</sub><br>ORF OUT HB P<br>O RF OUT HB N<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U<br>U |
| 16  | RF OUT<br>HB P | Complementary differential high band PA driver amplifier output.<br>See pin 15.  | See pin 15.  |
| 17  | RF OUT<br>WB N | Differential high band PA driver amplifier output.<br>This output is intended for wide band (W-CDMA) applications.<br>The output is an open collector. The output are matched off-chip.  | V <sub>CC</sub><br>V <sub>CC</sub><br>V <sub>CC</sub><br>V <sub>CC</sub><br>V <sub>CC</sub><br>O RF OUT WB P<br>O RF OUT WB N  |
| 18  | RF OUT<br>WB P | Complementary differential wideband PA driver amplifier output.<br>See pin 17.   | See pin 17.  |
| 19  | GND            | Ground.  |  |

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| Pin         | Function | Description   | Interface Schematic                                       |
|-------------|----------|---|---|
| 20          | MODE A   | Mode control pin. See the Logic Truth table.<br>CMOS Logic inputs: Logic $0=0V$ to $0.4V$ ; Logic $1=1.4V$ to $V_{CC}$ .  | See pin 6.  |
| 21          | VCC1     | Supply for modulator, VGA and PA driver amplifiers.   | VCC1<br>LO Quadrature<br>Generator and<br>Buffers<br>GND1 |
| 22          | I SIG P  | <ul> <li>In-phase I channel positive baseband input port.</li> <li>Best performance is achieved when the ISIGP and ISIGN are driven differentially with a 1.2V common mode DC voltage. The recommended differential drive level (V<sub>ISIGP</sub>-V<sub>ISIGN</sub>) is 1.2V<sub>P.P</sub> for EDGE, 0.8V<sub>P.P</sub> W-CDMA modulation and 1.0V<sub>P.P</sub> for GMSK modulation.</li> <li>This input should be DC-biased at 1.2V. In sleep mode an internal FET switch is opened, the input goes high impedance and the modulator is debiased.</li> <li>Phase or amplitude errors between the ISIGP and ISIGN signals will result in a common-mode signal which may result in an increase in the even order distortion of the modulation in the output spectrum.</li> <li>DC offsets between the ISIGP and ISIGN signals will result in increased carrier leakage. Small DC offsets may be deliberately applied between the ISIGP/ISIGN and QSIGP/QSIGN inputs to cancel out the LO leakage. The optimum corrective DC offsets will change with mode, frequency and gain control.</li> <li>Common-mode noise on the ISIGP and ISIGN should be kept low as it may degrade the noise performance of the modulator.</li> </ul> |   |
| 23          | I SIG N  | In-phase I channel negative baseband input port. See pin 22.  | See pin 22.   |
| 24          | MODE B   | Mode control pin. See the Logic Truth table.<br>CMOS Logic inputs: Logic $0=0V$ to $0.4V$ ; Logic $1=1.4V$ to $V_{CC}$ .  | See pin 6.  |
| Pkg<br>Base | DIE FLAG | Ground for LO section, modular, biasing, variable gain amplifier, and substrate.  |   |



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#### LO Frequency Planning Options for European 3GPP W-CDMA/EDGE

Recommended Frequency Plan: Frequency Doubler/Divide by 2/GMSK Modulator Bypass Modes

| Outpu      | t Frequency B | and         | Modulation<br>Format LO Port | LO Freque | ncy Range   | Comments    |  |
|------------|---------------|-------------|------------------------------|-----------|-------------|-------------|--|
| Band       | Lower Limit   | Upper Limit |                              |           | Lower Limit | Upper Limit |  |
| GSM850     | 824 MHz       | 849MHz      | EDGE 8PSK                    | LOHB      | 1648MHz     | 1698MHz     | F <sub>LO</sub> /2<br>Divide by 2                    |
| GSM850     | 824MHz        | 849MHz      | GSM GMSK                     | LOLB      | 824 MHz     | 849MHz      | F <sub>LO</sub> _bypass Bypass,<br>GMSK-modulated LO |
| GSM900     | 880MHz        | 915MHz      | EDGE 8PSK                    | LOHB      | 1760 MHz    | 1830MHz     | F <sub>LO</sub> /2<br>Divide by 2                    |
| GSM900     | 880MHz        | 915MHz      | GSM GMSK                     | LOLB      | 880MHz      | 915MHz      | F <sub>LO</sub> _bypass Bypass,<br>GMSK-modulated LO |
| DCS1800    | 1710MHz       | 1785 MHz    | EDGE 8PSK                    | LOLB      | 855 MHz     | 892.5MHz    | F <sub>LO</sub> x2<br>Frequency Doubler              |
| DCS1800    | 1710MHz       | 1785MHz     | GSM GMSK                     | LOHB      | 1710MHz     | 1785MHz     | F <sub>LO</sub> _bypass Bypass,<br>GMSK-modulated LO |
| PCS1900    | 1850MHz       | 1910 MHz    | EDGE 8PSK                    | LOLB      | 925MHz      | 955 MHz     | F <sub>LO</sub> x2<br>Frequency Doubler              |
| PCS1900    | 1850MHz       | 1910 MHz    | GSM GMSK                     | LOHB      | 1850MHz     | 1910MHz     | F <sub>LO</sub> _bypass Bypass,<br>GMSK-modulated LO |
| W-CDMA1950 | 1920MHz       | 1980 MHz    | 3GPP W-CDMA                  | LOLB      | 960MHz      | 990 MHz     | F <sub>LO</sub> x2<br>Frequency Doubler              |

#### On Frequency LO with GMSK Modulator Bypass Modes

| Outpu      | t Frequency B | and         | Modulation<br>Format | LO Port | LO Frequency Range |             | Comments   |
|------------|---------------|-------------|----------------------|---------|--------------------|-------------|--|
| Band       | Lower Limit   | Upper Limit |                      |         | Lower Limit        | Upper Limit |  |
| GSM850     | 824 MHz       | 849MHz      | EDGE 8PSK            | LOLB    | 824 MHz            | 849MHz      | F <sub>LO</sub> x1<br>On Frequency                   |
| GSM850     | 824MHz        | 849MHz      | GSM GMSK             | LOLB    | 824 MHz            | 849MHz      | F <sub>LO</sub> _bypass Bypass,<br>GMSK-modulated LO |
| GSM900     | 880MHz        | 915MHz      | EDGE 8PSK            | LOLB    | 880MHz             | 915MHz      | F <sub>LO</sub> x1<br>On Frequency                   |
| GSM900     | 880MHz        | 915MHz      | GSM GMSK             | LOLB    | 880MHz             | 915MHz      | F <sub>LO</sub> _bypass Bypass,<br>GMSK-modulated LO |
| DCS1800    | 1710MHz       | 1785MHz     | EDGE 8PSK            | LOHB    | 1710 MHz           | 1785MHz     | F <sub>LO</sub> x1<br>On Frequency                   |
| DCS1800    | 1710MHz       | 1785MHz     | GSM GMSK             | LOHB    | 1710 MHz           | 1785MHz     | F <sub>LO</sub> _bypass Bypass,<br>GMSK-modulated LO |
| PCS1900    | 1850MHz       | 1910MHz     | EDGE 8PSK            | LOHB    | 1850MHz            | 1910MHz     | F <sub>LO</sub> x1<br>On Frequency                   |
| PCS1900    | 1850MHz       | 1910MHz     | GSM GMSK             | LOHB    | 1850MHz            | 1910MHz     | F <sub>LO</sub> _bypass Bypass,<br>GMSK-modulated LO |
| W-CDMA1950 | 1920MHz       | 1980MHz     | 3GPP W-CDMA          | LOHB    | 1920MHz            | 1980 MHz    | F <sub>LO</sub> x1<br>On Frequency                   |



#### **Control Logic Truth Table**

| Mode Description   | Input Logic |           |              |             | Active RF<br>I/Os                     | Comment  |
|--|-------------|-----------|--------------|-------------|---------------------------------------|--|
|  | Mode A      | Mode B    | Mode C       | Mode D      |                                       | Expected Mode of Operation   |
|  |             |           | Sleep Mo     | de          |                                       |  |
| Sleep  | Х           | 0         | 0            | 0           |                                       | Sleep  |
|  | Fi          | equency D | oubler/Div   | ide by 2 0  | ptions                                |  |
| Wideband F <sub>LO</sub> x2 (High Power)<br>Modulator and frequency doubler<br>enabled   | 1           | 0         | 1            | 0           | LoLbP LoLbN<br>RFOutWb P<br>RFOutWb N | Bands: 1920MHz to 1980MHz<br>Modulation: 3GPP W-CDMA                 |
| Wideband F <sub>LO</sub> x2 (Medium Power)<br>Modulator and frequency doubler<br>enabled | 1           | 0         | 1            | 1           | LoLbP LoLbN<br>RFOutWb P<br>RFOutWb N | Bands: 1920MHz to 1980MHz<br>Modulation: 3GPP W-CDMA                 |
| Wideband F <sub>LO</sub> x2 (Low Power)<br>Modulator and frequency doubler<br>enabled    | 1           | 0         | 0            | 1           | LoLbP LoLbN<br>RFOutWb P<br>RFOutWb N | Bands: 1920MHz to 1980MHz<br>Modulation: 3GPP W-CDMA                 |
| High Band F <sub>LO</sub> x2<br>Modulator and frequency doubler<br>enabled               | 1           | 1         | 1            | 1           | LoLbP LoLbN<br>RFOutHb P<br>RFOutHb N | Bands: DCS1800 or PCS1900<br>Modulation: GMSK, TDMA and<br>8PSK EDGE |
| Low Band F <sub>LO</sub> /2<br>Modulator and divide by 2 enabled                         | 1           | 1         | 0            | 1           | LoHbP LoHbN<br>RFOutLb P<br>RFOutLb N | Bands: GSM900 or GSM850<br>Modulation: GMSK, TDMA and<br>8PSK EDGE   |
|  |             | GMSK N    | lodulator By | pass Option | S                                     |  |
| Low Band Bypass<br>Modulator bypass enabled  | X           | 1         | 0            | 0           | LoLbP LoLbN<br>RFOutLb P<br>RFOutLb N | Bands: GSM850 or GSM900<br>Modulation: GMSK                          |
| High Band Bypass<br>Modulator bypass enabled   | X           | 1         | 1            | 0           | LoHbP LoHbN<br>RFOutHb P<br>RFOutHb N | Bands: DCS1800 or PCS1900<br>Modulation: GMSK                        |
|  |             | On-F      | requency L   | O Options   |                                       |  |
| Wideband F <sub>LO</sub> x1 (High Power)<br>Modulator and on-frequency LO<br>enabled     | 0           | 0         | 1            | 0           | LoHbP LoHbN<br>RFOutWb P<br>RFOutWb N | Bands: 1920MHz to 1980MHz<br>Modulation: 3GPP W-CDMA                 |
| Wideband F <sub>LO</sub> x1 (Medium Power)<br>Modulator and on-frequency LO<br>enabled   | 0           | 0         | 1            | 1           | LoHbP LoHbN<br>RFOutWb P<br>RFOutWb N | Bands: 1920MHz to 1980MHz<br>Modulation: 3GPP W-CDMA                 |
| Wideband F <sub>LO</sub> x1 (Low Power)<br>Modulator and on-frequency LO<br>enabled      | 0           | 0         | 0            | 1           | LoHbP LoHbN<br>RFOutWb P<br>RFOutWb N | Bands: 1920MHz to 1980MHz<br>Modulation: 3GPP W-CDMA                 |
| High Band F <sub>LO</sub> x1<br>Modulator and on-frequency LO<br>enabled                 | 0           | 1         | 1            | 1           | LoHbP LoHbN<br>RFOutHb P<br>RFOutHb N | Bands: DCS1800 or PCS1900<br>Modulation: GMSK, TDMA and<br>8PSK EDGE |
| Low Band F <sub>LO</sub> x1<br>Modulator and on-frequency LO<br>enabled                  | 0           | 1         | 0            | 1           | LoLbP LoLbN<br>RFOutLb P<br>RFOutLb N | Bands: GSM900 to GSM850<br>Modulation: GMSK, TDMA and<br>8PSK EDGE   |





### **Application Information**

The baseband inputs of the RF3854 must be driven with balanced signals. Amplitude and phase matching <0.5dB and <0.5 degrees are recommended. Phase or gain imbalances between the complementary input signals will cause additional distortion including some second order baseband distortion.

The RF3854 is designed to be driven with either single-ended or differential LO signals. Driving the chip differentially is beneficial in improving the LO leakage performance. Decreasing the LO drive level will also improve LO leakage, but the output noise performance will be degraded. Driving the LO level too high will degrade linearity.

The ground lines for the LO sections are brought out of the chip independently from the ground to the RF and modulator sections. This is intended to give the board design the independence of isolating the LO signals from the RF output sections.

The RF3854 includes frequency doubler and divider modes that allow the LO to operate at half or twice the frequency depending on the application. This provides some flexibility in improving VCO isolation and LO leakage through frequency translation.

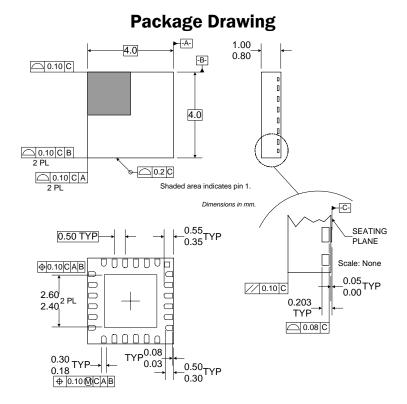
The RF outputs use open collector architecture and may be biased at voltages higher than  $V_{CC}$ . In practice, biasing at a higher voltage may improve the intermodulation performance. The load resistors are selected to provide sufficient output power while maintaining good linearity.

The GC DEC and  $V_{REF}$  output pins should be decoupled to ground. A 10nF capacitor on  $V_{REF}$  and a 1nF capacitor on GC CEC are recommended. The purpose of these capacitors is to filter out low frequency noise (20MHz) in the gain control lines that may cause noise on the RF signal. The capacitor on the GC DEC line will effect the settling time of the step response in power control voltage. A 1nF capacitor equates to around a 200 ns settling time; a 0.5 nF capacitor equates to a 100 ns settling time. There is a trade-off between setting time and phase noise as gain control is applied.

As with any RF circuit, the RF3854 is sensitive to PC board layout. The suggested schematic and board layout is included as a guideline. Proper grounding of the die flag under the chip is essential in achieving acceptable RF performance. A symmetric output structure will maintain signal balance while keeping the RF lines short will reduce losses. Proper routing and bypassing of the supply lines will improve stability and performance, especially under low gain control settings where carrier suppression becomes crucial. The location and value of the bypass capacitor on pin 1 is critical in promoting good carrier suppression and is designated to resonate out the series wire bond and PC board inductance.

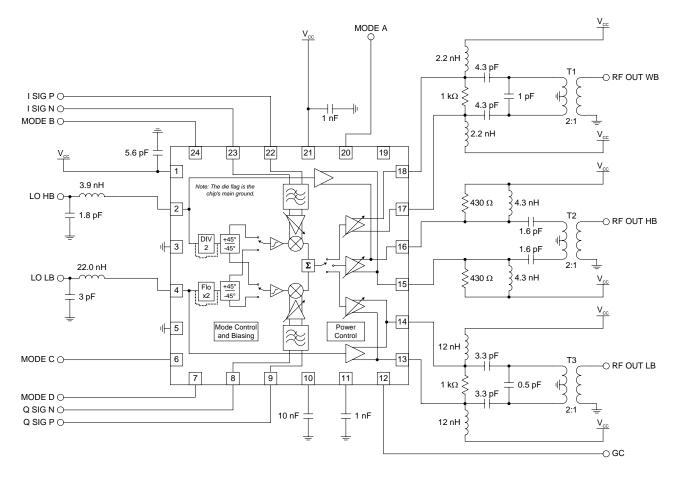


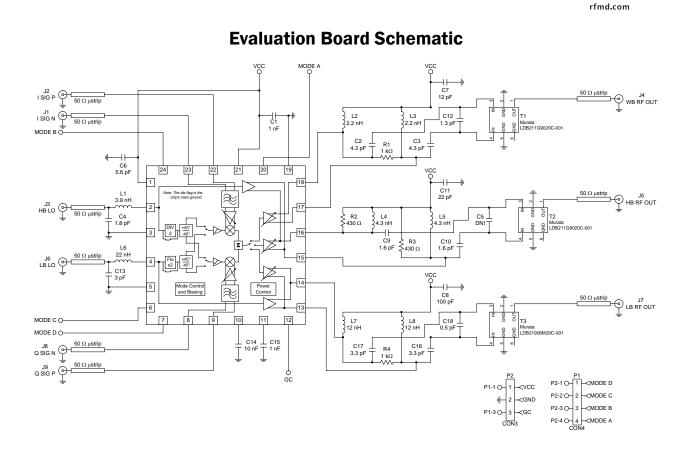






### **Application Schematic**





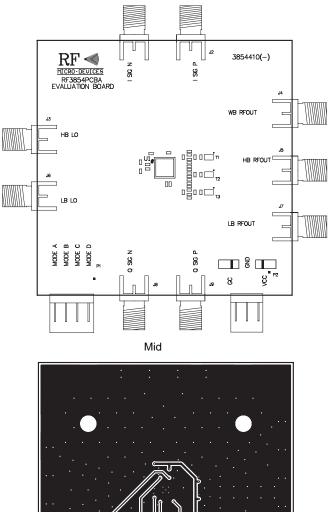
RFMD

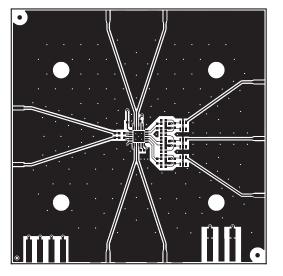




### Evaluation Board Layout Board Size 2.250" x 2.250"

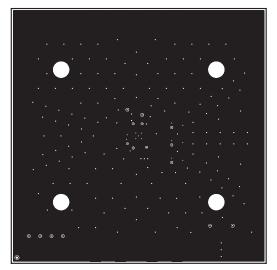
Board Thickness 0.032", Board Material FR-4, Multi-Layer
Assembly
T





Тор

Back







### **PCB Design Requirements**

#### **PCB Surface Finish**

The PCB surface finish used for RFMD's qualification process is Electroless Nickel, immersion Gold. Typical thickness is 3µinch to 8µinch Gold over 180µinch Nickel.

#### **PCB Land Pattern Recommendation**

PCB land patterns are based on IPC-SM-782 standards when possible. The pad pattern shown has been developed and tested for optimized assembly at RFMD; however, it may require some modifications to address company specific assembly processes. The PCB land pattern has been developed to accommodate lead and package tolerances.

#### PCB Metal Land Pattern

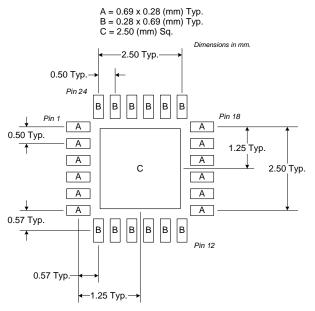


Figure 1. PCB Metal Land Pattern (Top View)





#### PCB Solder Mask Pattern

Liquid Photo-Imageable (LPI) solder mask is recommended. The solder mask footprint will match what is shown for the PCB Metal Land Pattern with a 2mil to 3mil expansion to accommodate solder mask registration clearance around all pads. The center-grounding pad shall also have a solder mask clearance. Expansion of the pads to create solder mask clearance can be provided in the master data or requested from the PCB fabrication supplier.

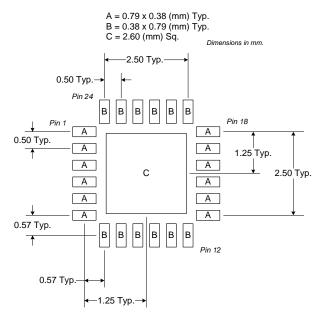


Figure 2. PCB Solder Mask Pattern (Top View)

#### Thermal Pad and Via Design

The PCB land pattern has been designed with a thermal pad that matches the exposed die paddle size on the bottom of the device.

Thermal vias are required in the PCB layout to effectively conduct heat away from the package. The via pattern shown has been designed to address thermal, power dissipation and electrical requirements of the device as well as accommodating routing strategies.

The via pattern used for the RFMD qualification is based on thru-hole vias with 0.203mm to 0.330mm finished hole size on a 0.5mm to 1.2mm grid pattern with 0.025mm plating on via walls. If micro vias are used in a design, it is suggested that the quantity of vias be increased by a 4:1 ratio to achieve similar results.

